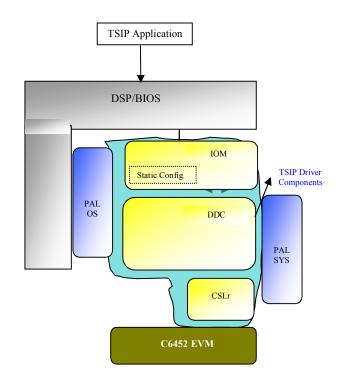


- Multi-instantiable and re-entrant safe driver
- Provides Asynchronous mode of operation.
- Programmable timeslot bitmap selection for A and B super-frame contexts.
- Data rate support of 8.192 Mbps for 2 links, 16.384 Mbps for 1 link.







The TSIP BIOS device driver adopts a scalable architecture that eases customization/extension

- Isolates H/W and OS Accesses, Easy to maintain & re-target to new platforms
- Supports Multiple Instances And Multiple DMATCU channels within the instance.

The driver is constituted of following sub components:

- TSIP IOM OS Specific (DSP/BIOS) Adaptation of TSIP Device Driver
- TSIP DDC OS Independent part of TSIP Driver Core. This also includes HAL and CSLr.
- System components BIOS: BIOS Abstraction.

The following table gives a quick overview of the supported IOM API services. These APIs can be invoked in two ways by using GIO or SIO. For help on interfaces refer to the TSIP Driver Help File:

tsip_mdBindDev	Initialize the TSIP device or port. It calls PSP_tsipCreate core function to do this. This function will be called from BIOS context to install and initialize TSIP driver for the given instance.
tsip_mdUnBindDev	Un-initialize the TSIP device or port. It calls PSP_tsipDelete core function to do this.
tsip_mdCreateChan	Creates the communication channel (Tx/Rx) for the data transfer by setting up TSIP DMATCU channel parameters. It calls PSP_tsipCreate () driver core function to achieve this.
tsip_mdDeleteChan	Delete the channel object and freeing up channel resources. It calls PSP_tsipDelete () driver core function to achieve this.
tsip_mdSubmitChan	Submit IO request packet to the TSIP driver. The submit command may be read/write/flush/abort. It calls PSP_tsipSubmit () for input/output command or PSP_tsipAbort () for abort/flush command.
tsip_mdControlChan	This is used to perform input output control (IOCTL) on the TSIP driver on the fly. It calls PSP_tsiploctl () to achieve this.



# **Driver Performance Characteristics**

TSIP DEVICE DRIVER SUB-COMPONENT	PROGRAM MEMORY (IN BYTES)	DATA MEMORY (IN BYTES)		
		MEMORY TYPE		TOTAL
		INITIALIZED	UN INITIALIZED	
<tsip iom=""></tsip>	1312	208	184	392
<tsip ddc=""></tsip>	16640	7968	7744	15712
Total	<b>16246</b>	8176	7928	16104

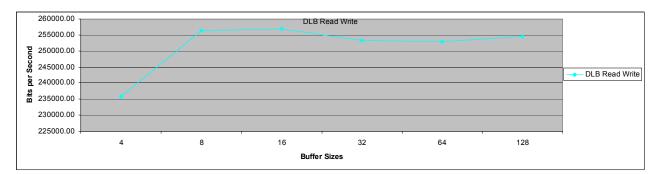
• System Components Total Memory (Code & Data): 32350 Bytes

# **Driver Profiling Characteristics**

API Profiled	Trial-1	Trial-2	Trial-3	Trial-4	Trial-5	Average (usec)	Maximum (usec)	Minimum (usec)
DEV_createDevice	13.00	12.00	15.00	12.00	14.00	13.20	15.00	12.00
DEV_deleteDevice	90.00	90.00	90.00	87.00	89.00	89.20	90.00	87.00
GIO_Create	75.00	87.00	75.00	82.00	76.00	79.00	87.00	75.00
GIO_Delete	15.00	13.00	13.00	14.00	13.00	13.60	15.00	13.00
GIO_Submit - Write	4.00	4.00	4.00	4.00	4.00	4.00	4.00	4.00
GIO_Submit-Read	7.00	4.00	7.00	4.00	6.00	5.60	7.00	4.00



## **Driver Performance Characteristics**



Test Setup Information	Buffer	DLB Read Write		
	Size (Bytes)	Bits/Sec	Pkts	Duration
	4	235866.13	442249	60
	8	256305.07	240286	60
API Interface	16	256829.87	120389	60
	32	253307.73	59369	60
	64	252791.47	29624	60
	128	254668.80	14922	60
Comments:				
Framesync - 8Khz				
4bytes per frame				

Expected data rate 256KHz

### References

[1] TSIP Functional Specifications

[2] BIOS Documentation from TI

[3] TSIP Device Driver Documentation

### Glossary

IOM	TI Terminology, Input / Output mini Driver.
DDC	TI Terminology, Device Driver Core that is OS independent
HAL	Hardware Abstraction Layer



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